

SMC1050

- Infrared LED
- 1050 nm, 1.3 mW
- SMD package, Ceramic
- Dimension: 3.0 x 2.0 x 1.1 mm
- Viewing Angle: 124°

Description



rev 1.1, 18.07.2017



SMC1050 is a surface mount InGaAsP LED with a typical peak wavelength of 1050 nm and radiation of 1.3 mW. It comes in SMD package (ceramic) and is sealed with silicone or epoxy resin.

Maximum Ratings (TCASE=25°C)

Deremeter	Symphol	Val	l la it		
Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		130	mW	
Forward Current	IF		100	mA	
Pulse Forward Current *1	IFP		1000	mA	
Reverse Voltage	VF		5	V	
Thermal Resistance	RTHJA		80	K/W	
Junction Temperature	T_J		120	°C	
Operating Temperature	T _{CASE}	- 40	+ 85	°C	
Storage Temperature	T _{STG}	- 40	+ 100	°C	
Lead Solder Temperature *2	T _{SLD}		+ 250	°C	

*1 duty=1%, pulse width = 10 μ s

*2 must be completed within 3 seconds

Electro-Optical Characteristics (TCASE=25°C)

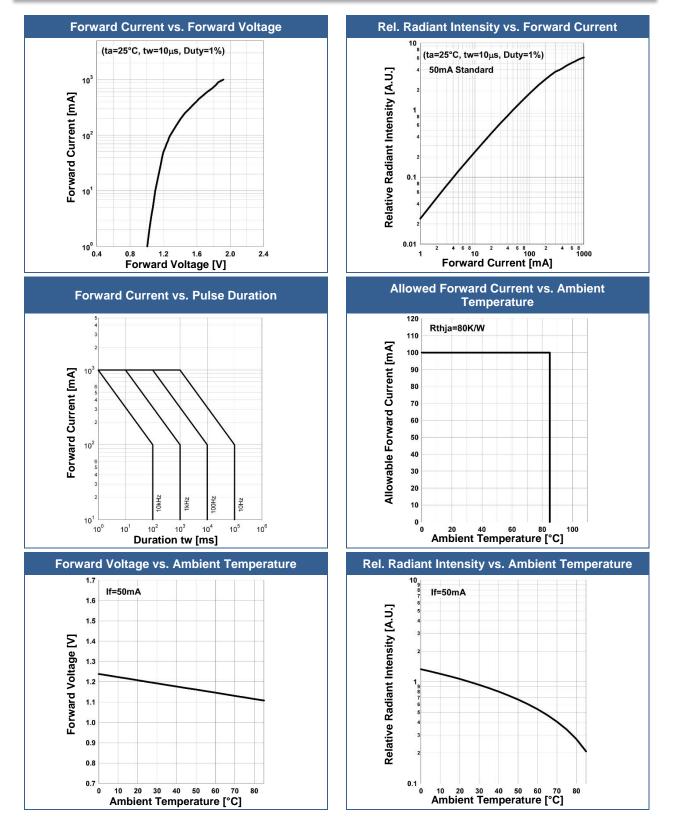
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λP	I⊧=50mA	1000		1100	nm
Half Width	$\Delta \lambda$	I⊧=50mA		50		nm
Forward Voltage	VF	I _F =50mA I _{FP} =1A		1.2 1.9	1.3	V
Radiated Power *1	Po	I _F =50mA I _{FP} =1A		5.0 30		mW
Radiant Intensity *2	IE	I _F =50mA I _{FP} =1A		2.2 13		mW/sr
Viewing Angle	φ	I⊧=50mA		132		deg.
Rise Time	tr	I⊧=50mA		80		ns
Fall Time	t _f	I⊧=50mA		30		ns

*1 measured by G8370-85

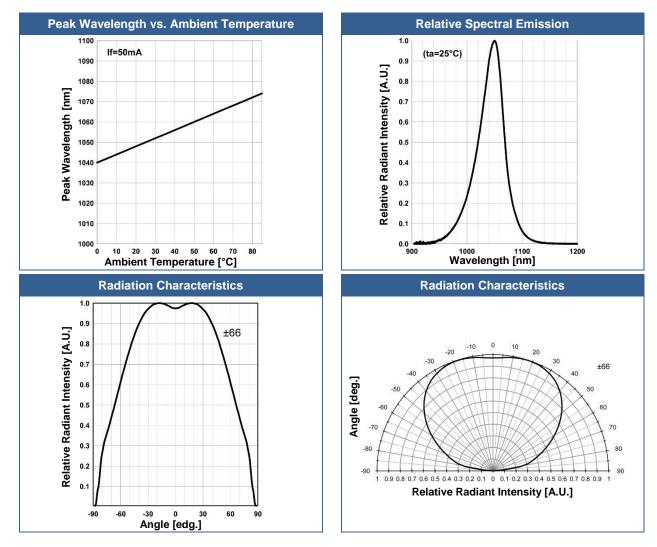
*2 measured by Ando Optical Multi Meter AQ2140 & AQ2742



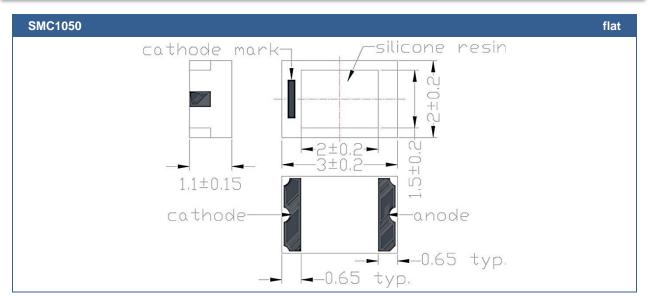
Typical Performance Curves







Outline Dimensions



All Dimensions in mm



Precautions

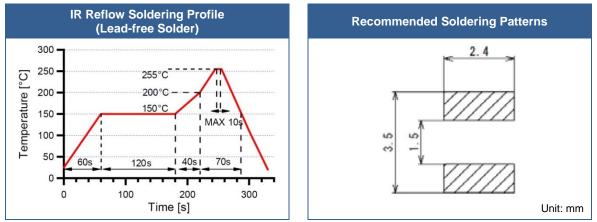
Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

Those LEDs do emit **invisible light**, which is invisible and may cause cancer. Do avoid exposure to the emitted light. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

© All Rights Reserved

The above specifications are for reference purpose only and subjected to change without prior notice